



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20240823000.1
Carrier Tape Cavity Pitch Change for select Device
Change Notification / Sample Request

Date: August 23, 2024
To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

Change Management Team
SC Business Services

20240823000.1
Change Notification / Sample Request
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS63070RNMR	NULL
TPS63070RNMT	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:		20240823000.1		PCN Date:		August 23, 2024	
Title:		Carrier Tape Cavity Pitch Change for select Device					
Customer Contact:		Change Management team		Dept:		Quality Services	
Proposed 1st Ship Date:		November 21, 2024		Sample requests accepted until:		N/A	
Change Type:							
☐	Assembly Site	☐	Design	☐	Wafer Bump Material		
☐	Assembly Process	☐	Data Sheet	☐	Wafer Bump Process		
☐	Assembly Materials	☐	Part number change	☐	Wafer Fab Site		
☐	Mechanical Specification	☐	Test Site	☐	Wafer Fab Material		
☒	Packing/Shipping/Labeling	☐	Test Process	☐	Wafer Fab Process		
PCN Details							
Description of Change:							
Texas Instruments Incorporated is announcing the qualification of 4mm carrier tape pitch for TPS63070RNMR/T device.							
Pack BOM		Package Size		Current		Proposed	
Tape pitch		3.0x2.5mm		8mm		4mm	
Reason for Change:							
Supply continuity							
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):							
None							
Impact on Environmental Ratings:							
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.							
RoHS		REACH		Green Status		IEC 62474	
☒ No Change		☒ No Change		☒ No Change		☒ No Change	
Changes to product identification resulting from this PCN:							
None							
Product Affected:							
TPS63070RNMR		TPS63070RNMT					

For questions regarding this notice, e-mails can be sent to Change Management team or your local Field Sales Representative.

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